

December 2013

FQB8N60C / FQI8N60C

N-Channel QFET® MOSFET

600 V, 7.5 A, 1.2 Ω

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 28 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 12 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

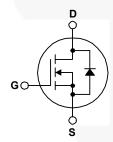
Features

- 7.5 A, 600 V, $R_{DS(on)}$ = 1.2 Ω (Max.) @ V_{GS} = 10 V, $I_D = 3.75 A$

- · RoHS Compliant







Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter	FQB8N60CTM / FQI8N60CTU	Unit
V _{DSS}	Drain-Source Voltage	600	V
I _D	Drain Current - Continuous (T _C = 25°C)	7.5	Α
	- Continuous (T _C = 100°C)	4.6	Α
I _{DM}	Drain Current - Pulsed (Not	1) 30	Α
V _{GSS}	Gate-Source Voltage	± 30	V
E _{AS}	Single Pulsed Avalanche Energy (Not	2) 230	mJ
I _{AR}	Avalanche Current (Not	1) 7.5	Α
E _{AR}	Repetitive Avalanche Energy (Not	1) 14.7	mJ
dv/dt	Peak Diode Recovery dv/dt (Not	3) 4.5	V/ns
	Power Dissipation (T _A = 25°C)*	3.13	W
P_D	Power Dissipation (T _C = 25°C)	147	W
	- Derate above 25°C	1.18	W/°C
T_J , T_{STG}	Operating and Storage Temperature Range	-55 to +150	°C
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds.	300	°C

Thermal Characteristics

Symbol	Parameter	FQB8N60CTM / FQI8N60CTU	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.85	
В	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
R _{θJA} Thermal Resistance, Junction to Ambient (*1 in² Pad of 2-oz Copper), Max.		40	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQB8N60CTM	FQB8N60C	D ² -PAK	Tape and Reel	330 mm	24 mm	800 units
FQI8N60CTU	FQI8N60C	I ² -PAK	Tube	N/A	N/A	50 units

Electrical Characteristics

T_C = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	600			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, Referenced to 25°C		0.7		V/°C
I _{DSS}	Zero Ceta Valta de Ducia Comunit	V _{DS} = 600 V, V _{GS} = 0 V			1	μΑ
	Zero Gate Voltage Drain Current	V _{DS} = 480 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 3.75 A		1.0	1.2	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 40 \text{ V}, I_D = 3.75 \text{ A}$		8.7		S
Dynam	ic Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		965	1255	рF
Coss	Output Capacitance			105	135	pF
C _{rss}	Reverse Transfer Capacitance			12	16	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 300 \text{ V}, I_D = 7.5\text{A},$		16.5	45	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		60.5	130	ns
t _{d(off)}	Turn-Off Delay Time			81	170	ns
t _f	Turn-Off Fall Time	(Note 4)		64.5	140	ns
Qg	Total Gate Charge	V _{DS} = 480 V, I _D = 7.5A,		28	36	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		4.5		nC
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Drain-Source Diode Characteristics and Maximum Ratings

		•				
IS	Maximum Continuous Drain-Source Diode Forward Current				7.5	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F	orward Current			30	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 7.5 \text{ A}$			1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_{S} = 7.5 \text{ A,}$		365		ns
Q _{rr}	Reverse Recovery Charge	$dI_F / dt = 100 A/\mu s$		3.4		μС

 Q_{gd}

Gate-Drain Charge

nC

12

Notes: 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.L = 7.3 mH, I_{AS} = 7.5 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C. 3. $I_{SD} \le 7.5$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, starting T_{J} = 25°C. 4. Essentially independent of operating temperature.

Typical Characteristics

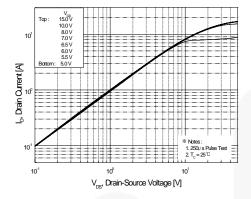


Figure 1. On-Region Characteristics

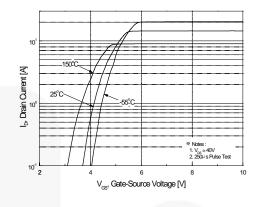


Figure 2. Transfer Characteristics

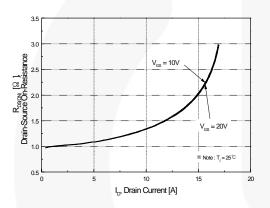


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

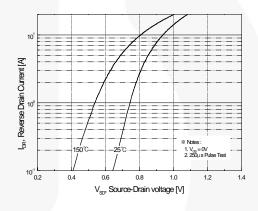


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

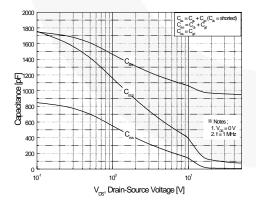


Figure 5. Capacitance Characteristics

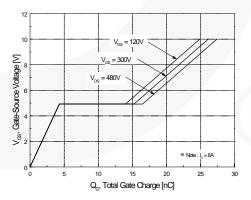


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

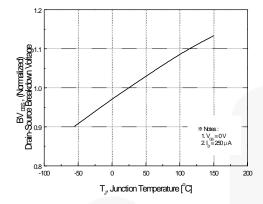
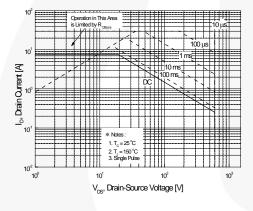


Figure 7. Breakdown Voltage Variation vs Temperature

Figure 8. On-Resistance Variation vs Temperature



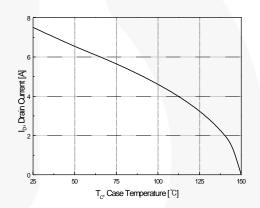


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

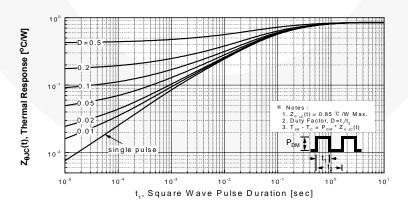


Figure 11. Transient Thermal Response Curve

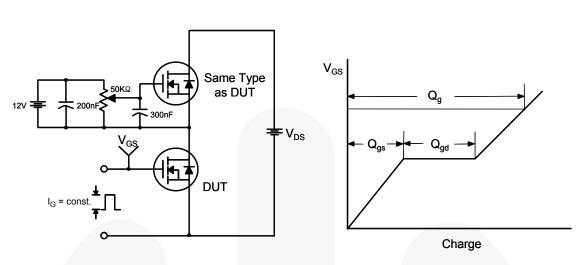


Figure 12. Gate Charge Test Circuit & Waveform

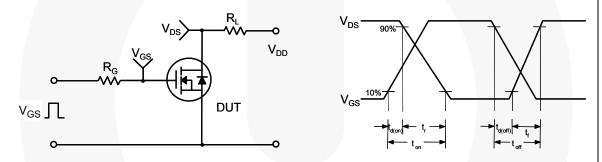


Figure 13. Resistive Switching Test Circuit & Waveforms

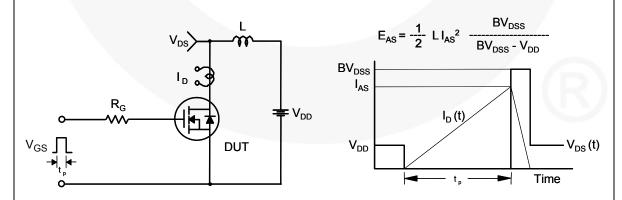
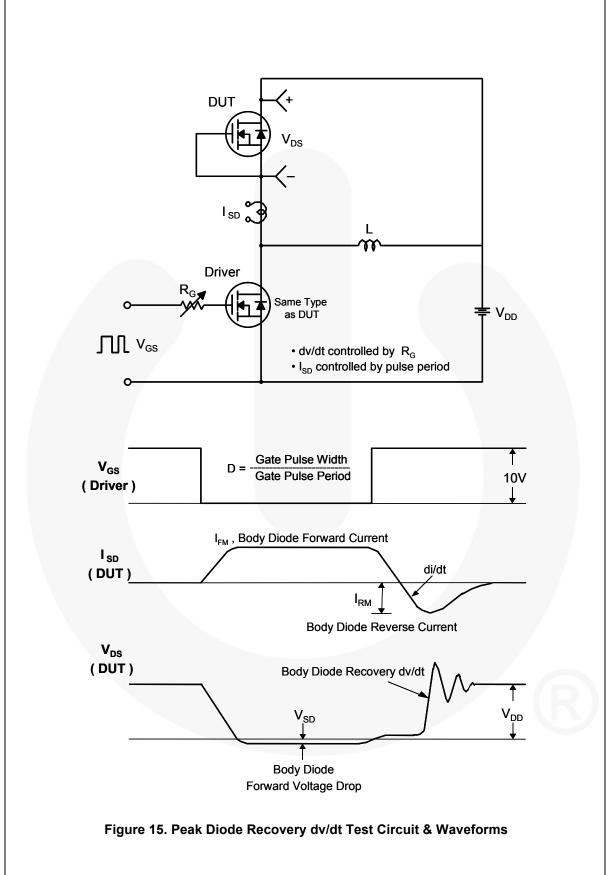


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Mechanical Dimensions

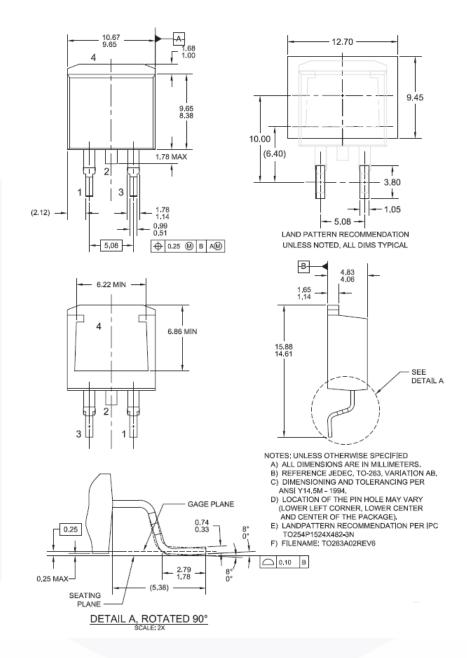


Figure 16. TO263 (D²PAK), Molded, 2-Lead, Surface Mount

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Mechanical Dimensions

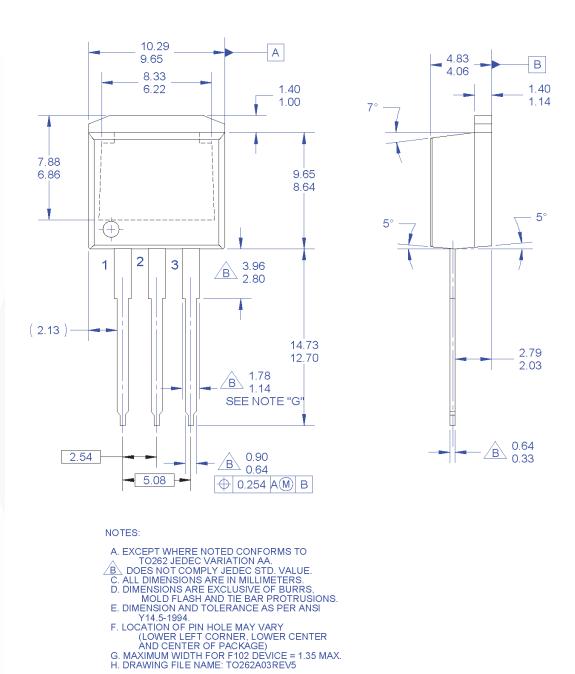


Figure 17. TO262 (I²PAK), Molded, 3-Lead, Jedec Variation AA

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